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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Obsolete
Core Processor	Z8
Core Size	8-Bit
Speed	10MHz
Connectivity	-
Peripherals	WDT
Number of I/O	13
Program Memory Size	512B (512 x 8)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	32 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8e00010sec

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

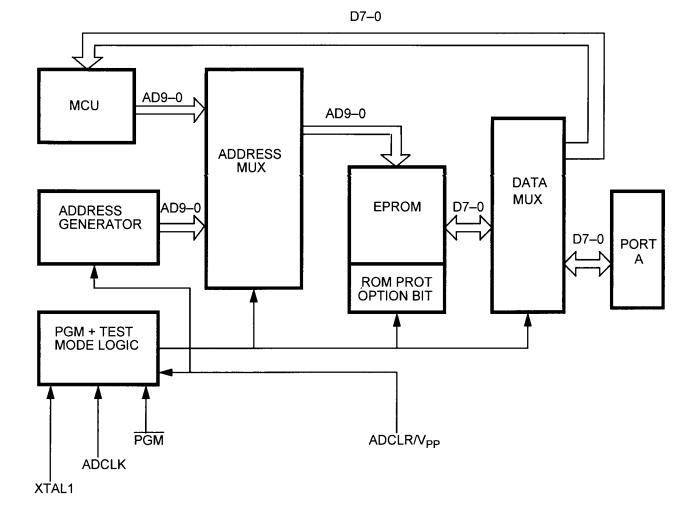


Figure 2. EPROM Programming Mode Block Diagram

PIN DESCRIPTION

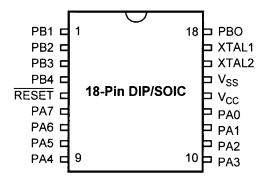


Figure 3. 18-Pin DIP/SOIC Pin Identification

Table 1. 18-Pin DIP/SOIC Pin Assignments

Standard Me	ode		
Pin #	Symbol	Function	Direction
1–4	PB1–PB4	Port B, Pins 1,2,3,4	In/Output
5	RESET	Reset	Input
6–9	PA7–PA4	Port A, Pins 7,6,5,4	In/Output
10–13	PA3-PA0	Port A, Pins 3,2,1,0	In/Output
14	V _{CC}	Power Supply	
15	V _{SS}	Ground	
16	XTAL2	Crystal Oscillator Clock	Output
17	XTAL1	Crystal Oscillator Clock	Input
18	PB0	Port B, Pin 0	In/Output

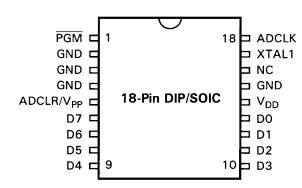


Figure 4. 18-Pin DIP/SOIC Pin Identification; EPROM Programming Mode

Table 2. 18-Pin DIP/SOIC Pin Assignments; EPROM Programmable Mode

EPROM Pr	ogramming Mode		
Pin #	Symbol	Direction	
1	PGM	Program Mode	Input
24	GND	Ground	
5	ADCLR/V _{PP}	Clear Clock/Program Voltage	Input
6–9	D7-D4	Data 7,6,5,4	In/Output
10–13	D3-D0	Data 3,2,1,0	In/Output
14	V _{DD}	Power Supply	
15	GND	Ground	
16	NC	No Connection	
17	XTAL1	1 MHz Clock	Input
18	ADCLK	Address Clock	Input

PGM C GND C GND C GND C ADCLR/V _{PP} C NC C D7 C D6 C D5 C D4 C		20-Pin SSOP		ADCLK XTAL1 NC GND V _{DD} NC D0 D1 D2 D3
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Figure 6. 20-Pin SSOP Pin Identification; EPROM Programming Mode

Table 4. 20-Pin SSOP Pin Assignments; EPROM Programm	ning Mode

Pin #	Symbol	Function	Direction	
1	PGM	Program Mode	Input	
2–4	GND	Ground		
5	ADCLR/V _{PP}	Clear Clock/Program Voltage	Input	
6	NC	No Connection		
7–10	D7-D4	Data 7,6,5,4	In/Output	
11–14	D3-D0	Data 3,2,1,0	In/Output	
15	NC	No Connection		
16	V _{DD}	Power Supply		
17	GND	Ground	Ground	
18	NC	No Connection		
19	XTAL1	1 MHz Clock	Input	
20	ADCLK	Address Clock	Input	

ABSOLUTE MAXIMUM RATINGS

Parameter	Min	Мах	Units	Note
Ambient Temperature under Bias	40	+105	С	
Storage Temperature	-65	+150	С	
Voltage on any Pin with Respect to V _{SS}	-0.6	+7	V	1
Voltage on V _{DD} Pin with Respect to V _{SS}	-0.3	+7	V	
Voltage on RESET Pin with Respect to V _{SS}	-0.6	V _{DD} +1	V	2
Total Power Dissipation		880	mW	
Maximum Allowable Current out of V _{SS}		80	mA	
Maximum Allowable Current into V _{DD}		80	mA	
Maximum Allowable Current into an Input Pin	600	+600	mA	3
Maximum Allowable Current into an Open-Drain Pin	-600	+600	mA	4
Maximum Allowable Output Current Sunk by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sourced by Any I/O Pin		25	mA	
Maximum Allowable Output Current Sunk by Port A		40	mA	
Maximum Allowable Output Current Sourced by Port A		40	mA	
Maximum Allowable Output Current Sunk by Port B		40	mA	
Maximum Allowable Output Current Sourced by Port B		40	mA	

Notes:

1. Applies to all pins except the RESET pin and where otherwise noted.

2. There is no input protection diode from pin to V_{DD} .

3. Excludes XTAL pins.

4. Device pin is not at an output Low state.

Stresses greater than those listed under Absolute Maximum Ratings can cause permanent damage to the device. This rating is a stress rating only. Functional operation of the device at any condition above those indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for an extended period can affect device reliability. Total power dissipation should not exceed 880 mW for the package. Power dissipation is calculated as follows:

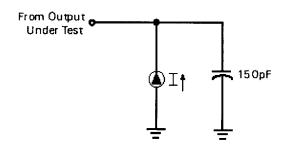
Total Power Dissipation = $V_{DD} \times [I_{DD} - (\text{sum of } I_{OH})]$

+ sum of [($V_{DD} - V_{OH}$) x I_{OH}]

+ sum of $(V_{0L} \times I_{0L})$

STANDARD TEST CONDITIONS

The characteristics listed below apply for standard test conditions as noted. All voltages are referenced to Ground. Positive current flows into the referenced pin (Figure 7).





CAPACITANCE

 $T_A = 25^{\circ}C$, $V_{CC} = GND = 0V$, f = 1.0 MHz, unmeasured pins returned to GND.

Parameter	Min	Max
Input capacitance	0	12 pF
Output capacitance	0	12 pF
I/O capacitance	0	12 pF

			$T_{A} = -40^{\circ}$	C to +105°C				
Sym	Parameter	V _{cc} ¹	Min	Мах	Typical @ 25°C ²	Units	Conditions	Notes
I CC2	Standby Current	4.5V		700	250	nA	STOP Mode V_{IN} = 0V, V_{CC}	5
		5.5V		700	250	nA	STOP Mode V_{IN} = 0V, V_{CC}	5

Notes:

1. The V_{CC} voltage specification of 4.5 V and 5.5 V guarantees 5.0 V \pm 0.5 V. 2. Typical values are measured at V_{CC} = 3.3V and V_{CC} = 5.0V. 3. All outputs unloaded, I/O pins floating, and all inputs are at V_{CC} or V_{SS} level.

4. CL1 = CL2 = 22 pF.

5. Same as note 3 except inputs at V_{CC} .

Z8^{PLUS} CORE

The Z8E000 is based on the ZiLOG Z8^{Plus} Core Architecture. This core is capable of addressing up to 64KBytes of program memory and 4KBytes of RAM. Register RAM is accessed as either 8- or 16-bit registers, using a combination of 4-, 8-, and 12-bit addressing modes. The architecture sup-

ports up to 15 vectored interrupts from external and internal sources. The processor decodes 44 CISC instructions, using six addressing modes. See the $Z8^{Plus}$ User's Manual for more information.

RESET

This section describes the Z8E000 reset conditions, reset timing, and register initialization procedures. Reset is generated by the Reset Pin, Watch-Dog Timer (WDT), and Stop-Mode Recovery (SMR).

A system reset overrides all other operating conditions and puts the Z8E000 into a known state. To initialize the chip's internal logic, the RESET input must be held Low for at least 30 XTAL clock cycles. The control registers and ports are reset to their default conditions after a reset from the $\overrightarrow{\text{RESET}}$ pin. The control registers and ports are not reset to their default conditions after wakeup from Stop Mode or WDT timeout.

During $\overline{\text{RESET}}$, the program counter is loaded with 0020H. I/O ports and control registers are configured to their default reset state. Resetting the Z8E000 does not affect the contents of the general-purpose registers.

RESET PIN OPERATION

The Z8E000 hardware $\overline{\text{RESET}}$ pin initializes the control and peripheral registers, as indicated in Table 6. Specific reset values are indicated by 1 or 0, while bits whose states are unchanged are indicated by the letter U.

RESET must first be held Low until the oscillator stabilizes. From than point, the pin then must be held for an additional 30 XTAL clock cycles to be sure that the internal reset is complete. The **RESET** pin has a Schmitt-Trigger input with a trip point. There is no High side protection diode. The user should place an external diode from **RESET** to V_{CC} . The internal pull-up resistor on the $\overline{\text{RESET}}$ pin is approximately 500 K Ω , typical.

Program execution starts 10 XTAL clock cycles after $\overline{\text{RE-SET}}$ has returned High. The initial instruction fetch is from location 0020H. Figure 9 indicates reset timing.

After a reset, the first routine executed must be one that initializes the TCTLHI control register to the required system configuration. This routine is then followed by initialization of the remaining control registers.

Register	r				Bi	ts				
(HEX)	Register Name	7	6	5	4	3	2	1	0	Comments
FF	Stack Pointer	0	0	U	U	U	U	U	U	Stack pointer is not affected by RESET
FE	Reserved									
FD	Register Pointer	U	U	U	U	0	0	0	0	Register pointer is not affected by RESET
FC	Flags	U	U	U	U	U	U	*	*	Only WDT & SMR flags are affected by RESET
FB	Interrupt Mask	0	0	0	0	0	0	0	0	All interrupts masked by RESET
FA	Interrupt Request	0	0	0	0	0	0	0	0	All interrupt requests cleared by RESET
F9–F0	Reserved									
EF-E0	Virtual Copy									Virtual Copy of the Current Working Register Set
DF–D8	Reserved									
D7	PortB Spec. Func.	0	0	0	0	0	0	0	0	Deactivates all port special functions after RESET
D6	PortB Directional Control	0	0	0	0	0	0	0	0	Defines all bits as inputs in PortB after RESET
D5	PortB Output	U	U	U	U	U	U	U	U	Output register not affected by RESET

Table 6. Control and Peripheral Register Reset Values

RESET PIN OPERATION (Continued)

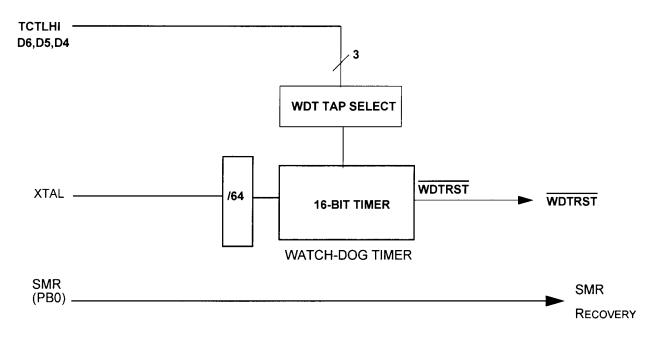
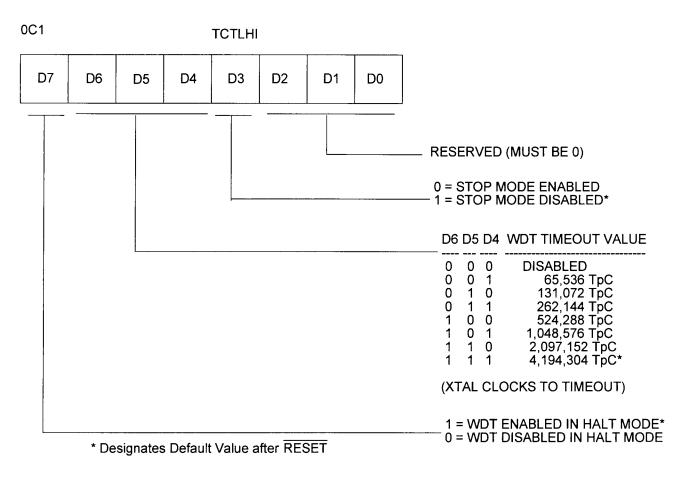


Figure 11. Z8E000 Reset Circuitry with WDT and SMR





Note: The WDT can only be disabled via software if the first instruction out of RESET performs this function. Logic within the Z8E000 will detect that it is in the process of executing the first instruction after the part leaves RE-SET. During the execution of this instruction, the upper five bits of the TCTLHI register can be written. After this first instruction, hardware will not allow the upper five bits of this register to be written.

The TCTLHI bits for control of the WDT are described below:

WDT Time Select (D6, D5, D4). Bits 6, 5, and 4 determine the time-out period. Table 7 indicates the range of timeout values that can be obtained. The default values of D6, D5, and D4 are all 1, thus setting the WDT to its maximum timeout period when coming out of RESET.

D6	D5	D4	Crystal Clocks to Timeout	Time-Out Using a10 MHz Crystal
0	0	0	Disabled	Disabled
0	0	1	65,536 TpC	6.55 ms
0	1	0	131,072 TpC	13.11 ms
0	1	1	262,144 TpC	26.21 ms
1	0	0	524,288 TpC	52.43 ms
1	0	1	1,048,576 TpC	104.86 ms
1	1	0	2,097,152 TpC	209.72 ms
1	1	1	4,194,304 TpC	419.43 ms

Notes:

TpC = XTAL clock cycle.

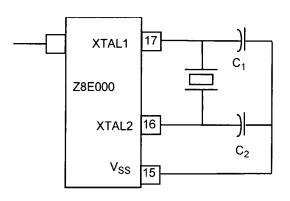
The default on reset is D6 = D5 = D4 = 1.

Table 7. Time-Out Period of the WDT

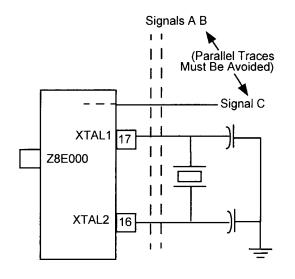
DS003600-Z8X1098

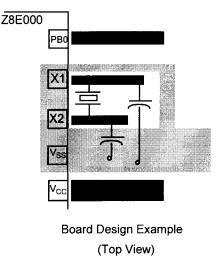
OSCILLATOR OPERATION (Continued)

• V_{CC} power lines should be separated from the clock oscillator input circuitry.



Clock Generator Circuit





Resistance between XTAL1 or XTAL2 and the other

pins should be greater than 10 M Ω .



Crystals and Resonators

Crystals and ceramic resonators (Figure 16) should have the following characteristics to ensure proper oscillator operation:

Crystal Cut	AT (crystal only)
Mode	Parallel, Fundamental Mode
Crystal Capacitance	<7pF
Load Capacitance	10pF < CL < 220 pF,
	15 typical
Resistance	100 ohms max

Depending on operation frequency, the oscillator can require the addition of capacitors C_1 and C_2 (shown in Figure 17 and Figure 18). The capacitance values are dependent on the manufacturer's crystal specifications.

LC OSCILLATOR

The Z8E000 oscillator can use a LC network to generate a XTAL clock (Figure 18).

The frequency stays stable over V_{CC} and temperature. The oscillation frequency is determined by the equation:

Frequency =
$$\frac{1}{2\pi (LC_T)^{1/2}}$$

where L is the total inductance including parasitics and C_T is the total series capacitance including the parasitics.

Simple series capacitance is calculated using the following equation:

1/ C _T	$= 1/C_1 + 1/C_2$
If C ₁	= C ₂
1/C _T	= 2 C ₁
C ₁	= 2 C _T

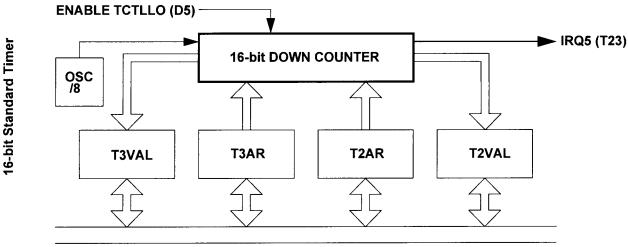
A sample calculation of capacitance C_1 and C_2 for 5.83-MHz frequency and inductance value of 27 uH is illustrated as follows:

5.83 (10⁶) =
$$\frac{1}{2\pi [2.7 (10^{-6}) C_T] 1/2}$$

 C_{T} = 27.6 pf Thus C₁ = 55.2 pf and C₂ = 55.2 pf.

TIMERS

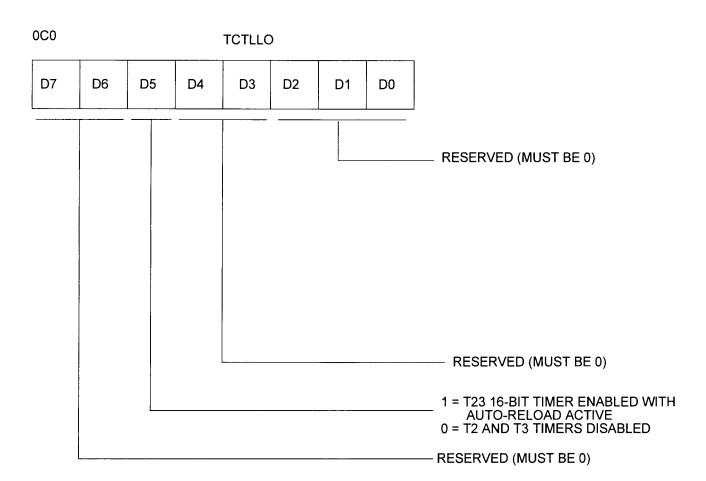
Two 8-bit timers (T2 and T3), are provided but can only operate in cascade to function as a 16-bit standard timer (Figure 19).



Internal Data Bus

Figure 19. Timer Block Diagram

ZiLOG



Note: Timer T23 is a standard 16-bit timer formed by cascading 8-bit timers t3(msb) and t2(lsb).



Each 8-bit timer is equipped with a pair of readable and writable registers, which are both readable and writable. One of the registers is defined to contain the auto-initialization value for the timer, while the second register contains the current value for the timer. When a timer is enabled, the timer will decrement whatever value is currently held in its count register. From that point, the timer continues decrementing until it reaches 0, at which time an interrupt will be generated and the contents of the auto-initialization register are optionally copied into the count value register. If auto-initialization is not enabled, the timer will stop counting upon reaching 0, and control logic will clear the appropriate control register bit to disable the timer. This operation is referred to as a "single-shot". If auto-initialization is enabled, the timer will continue counting from the initialization value. Software should not attempt to use registers that are defined as having timer functionality for any other purpose.

Software is allowed to write to any register at any time, but care should be taken if timer registers are updated while the timer is enabled. If software updates the count value while the timer is in operation, the timer will continue counting based upon the software-updated value. Strange behavior can result if the software update occurred at exactly the point that the timer was reaching 0 to trigger an interrupt and/or reload.

Similarly, if software updates the initialization value register while the timer is active, the next time that the timer reaches 0, it will be initialized using the updated value. Again, strange behavior could result if the initialization value register is being written while the timer is in the process of being initialized. Whether initialization is done with the new or old value is a function of the exact timing of the write operation. In all cases, the Z8E000 will prioritize the software write above that of a decrementer writeback. Howev-

RESET CONDITIONS

After a hardware RESET, the timers are disabled. See Table 5 for timer control, value, and auto-initialization register status after RESET.

I/O PORTS

The Z8E000 has 13 lines dedicated to input and output. These lines are grouped into two ports known as Port A and Port B. Port A is an 8-bit port that is bit-programmable as either inputs or outputs. Port B can be programmed to provide standard input/output or the following special functions: SMR input and external interrupt inputs.

All ports have push-pull CMOS outputs. In addition, the outputs of Port A, on a bit-wise basis, can be configured for open-drain operation. As such, the register values for "/" at a given bit position only affect the bit in question.

Each port is defined by a set of four control registers. See Figure 21.

Directional Control and Special Function Registers

Each port on the Z8E000 has an associated and dedicated Directional Control Register that determines on a bit-wise basis whether a given port bit will operate as an input or as an output.

Each port on the Z8E000 has a Special Function Register that, in conjunction with the directional control register, implements on a bit-wise basis, and supports special functionality that can be defined for each particular port bit.

Input and Output Value Registers

Each port has an Output Value Register and an Input Value Register. For port bits configured as an input by means of the Directional Control Register, the Input Value Register for that bit position will contain the current synchronized input value.

REGISTER	ADDRESS	IDENTIFIER
Port B SPECIAL FUNCTION	0D7H	PTBSFR
Port B DIRECTIONAL CONTROL	0D6H	PTBDIR
Port B OUTPUT VALUE	0D5H	PTBOUT
Port B INPUT VALUE	0D4H	PTBIN
Port A SPECIAL FUNCTION	0D3H	PTASFR
Port A DIRECTIONAL CONTROL	0D2H	PTADIR
Port A OUTPUT VALUE	0D1H	PTAOUT
Port A INPUT VALUE	ODOH	PTAIN

Figure 21. Z8E000 I/O Ports Registers

For port bits configured as an output by means of the Directional Control Register, the value held in the corresponding bit of the Output Value Register is driven directly onto the output pin. The opposite register bit for a given pin (the output register bit for an input pin and the input register bit for an output pin) will hold their previous value. They will not be changed by hardware nor will they have any effect on the hardware.

READ/WRITE OPERATIONS

The control for each port is done on a bit-wise basis. All bits are capable of operating as inputs or outputs, depending upon the setting of the port's directional control register. If configured as an input, each bit is provided a Schmitt-trigger. The output of the Schmitt-trigger is latched twice to perform a synchronization function, while the output of the synchronizer is fed to the port input register, which can be read by software.

A write to a port input register has the effect of updating the contents of the input register, but subsequent reads will not necessarily return the same value that was written. If the bit in question is defined as an input, the input register for that bit position will contain the current synchronized input value. Thus, writes to that bit position will be overwritten on the next clock cycle with the newly sampled input data. However, if the particular port bit is programmed as an output, the input register for that bit will retain the softwareupdated value. The port bits that are programmed as outputs do not sample the value being driven out.

Any bit in either port can be defined as an output by setting the appropriate bit in the directional control register. If such is the case, the value held in the appropriate bit of the port output register is driven directly onto the output pin.

Note: The above result does not necessarily reflect the actual output value. If an external error is holding an output pin

either High or Low against the output driver, the software read will return the *required* value, not the actual state caused by the contention. When a bit is defined as an output, the Schmitt-trigger on the input will be disabled to save power.

Updates to the output register will take effect based upon the timing of the internal instruction pipeline; however, this timing is referenced to the rising edge of the clock. The output register can be read at any time, and will return the current output value that is held. No restrictions are placed on the timing of reads and/or writes to any of the port registers with respect to the others, but care should be taken when updating the directional control and special function registers.

When updating a directional control register, the special function register should first be disabled. If this precaution is not taken, spurious events could take place as a result of the change in port I/O status. This precaution is especially important when defining changes in Port B, as the spurious event referred to above could be one or more interrupts. Clearing of the SFR register should be the first step in configuring the port, and setting the SFR register should be the final step in the port configuration process. To ensure deterministic behavior, the SFR register should not be written until the pins are being driven appropriately and all initialization has been completed.

PORT B

Port B Description

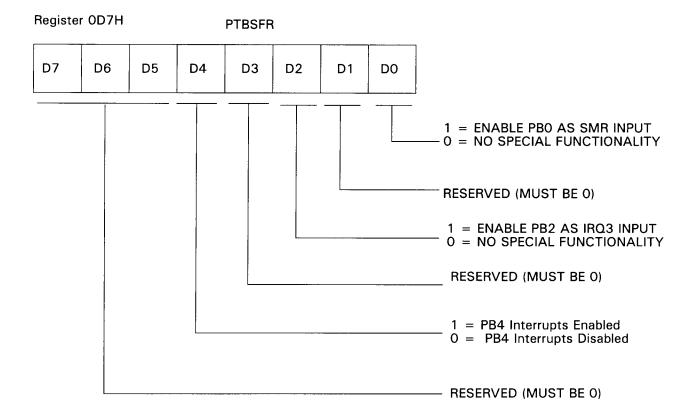
Port B is a 5-bit, bidirectional, CMOS-compatible I/O port. These five I/O lines can be configured under software control to be an input or output, independently. Input buffers are Schmitt-triggered. See Figure 29 through Figure 33 for diagrams of all five Port B pins.

In addition to standard input/output capability on all five pins of Port B, each pin provides special functionality as indicated in Table 8:

Port Pin	Input Special Function	Output Special Function
PB0	Stop Mode Recovery Input	None
PB1	None	None
PB2	IRQ3	None
PB3	None	None
PB4	IRQ1/IRQ4	None

Table 8. Port B Special Functions

Special functionality is invoked via the Port B Special Function Register. See Figure 28 for the arrangement and control conventions for this register.



PORT B-PIN 0 CONFIGURATION

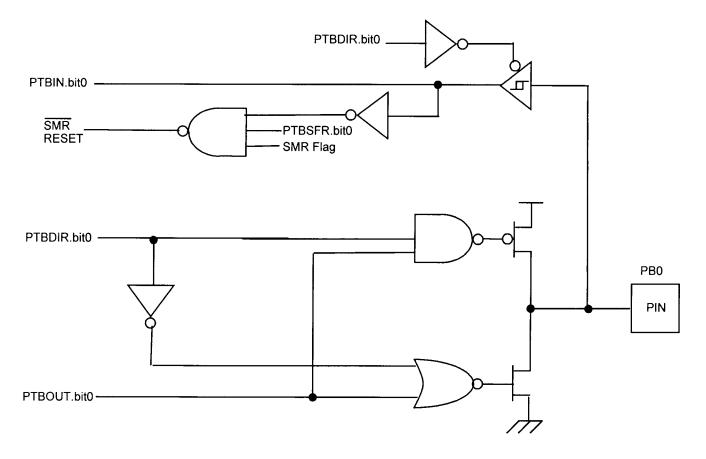


Figure 29. Port B Pin 0 Diagram

PORT B-PIN 1 CONFIGURATION

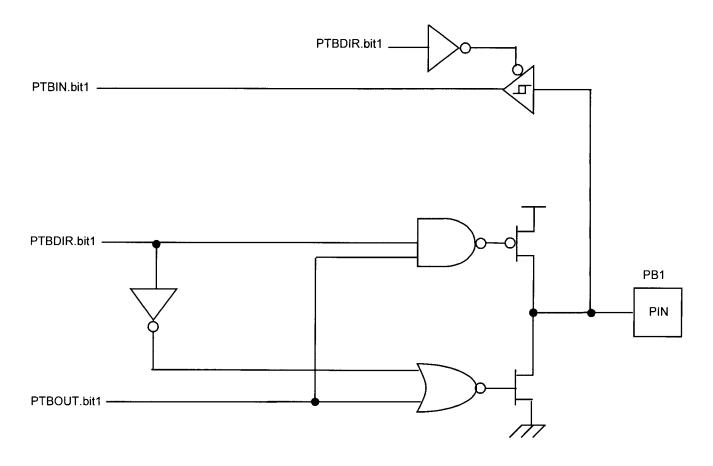
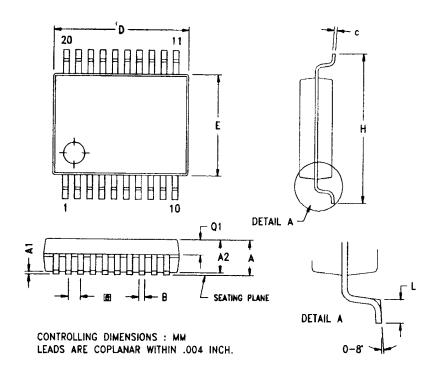


Figure 30. Port B Pin 1 Diagram



SYMBOL	MILLIMETER			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.73	1.85	1.98	0.068	0.073	0.078
A1	0.05	0.13	0.21	0.002	0.005	0.008
A2	1.68	1.73	1.83	0.066	0.068	0.072
8	0.25	0.30	0.38	0.010	0.012	0.015
С	0.13	0.15	0.22	0.005	0.006	0.009
D	7.07	7.20	7.33	0.278	0.283	0.289
Ε	5.20	5.30	5.38	0.205	0.209	0.212
e	0.65 TYP			0.0256 TYP		
н	7.65	7.80	7.90	0.301	0.307	0.311
L	0.56	0.75	0.94	0.022	0.030	0.037
Q1	0.74	0.78	0.82	0.029	0.031	0.032

Figure 41. 20-Pin SSOP Package Diagram

Pre-Characterization Product:

The product represented by this data sheet is newly introduced and ZiLOG has not completed the full characterization of the product. The data sheet states what ZiLOG knows about this product at this time, but additional features or nonconformance with some aspects

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